

Noyan Circuits www.noyancircuits.ir

		NOYAN Circuits
Specifications for Stencil		
1. Part No. :		
2. Required QTY (PCS)		
3. Stencil For		Top Layer Bottom Layer Both Layers in one Stencil Both Layers in Seperated Stencils
4. Type of Stencil	a) Technics	Laser-Cut Electroic Polishing Other
	b) Used for	□ Solder Paste □ Adhesive red Glue □ Other
5. Metal Mask	a) Material	Steel Aluminium Other
	b) Thickness (h)	0.1mm 0.12mm 0.15mm 0.18mm 0.20mm 0.25mm 0.30mm 0.40mm 0.50mm
	c) Outline (m*n)	□ N/A □ Size: mm □ See Attached Drawing
6. Screen Frame	a) Material	Aluminium
	b) Frame Size	Image: No need (X*Y) X=mm, Y=mm Side I * Side II 18*22mm 20*30mm 25*38mm 30*40mm 40*40mm
	c) Bolt	□ N0 □ YES (□ M3 □ M6 □ 1/4" □ See attached drawing)
7. Fiducial Mark	a) Required	No Need OTY:Match by PCB Fiducial)
	b) Position	□ Top Layer □ Bottom Layer □ Through Etch □ Half Etch
8. Aperture	a) Location	□ Center □Offset □Make edge from Frame Sizemm S□attached drawing
	b) Direction	
	c) Size	□ N/A □1:1 same as the paste file □ Lead Component:10% Reduction for pitch less than 0.6mm and 1/1 as pattern file for else
9. Adhesive	Layer Name:	Dot Slot
10. Prevent Stannum Ball		NO VES (DI Control Component)
11. Special Note:		□ NO □ YES , As Following Notes:
12. Necassary Attach	Stencill File	Complete PCB File Gerber File (Pattern, Legend, Keep out, Solder Paste Fiducial Location
13. Stencill Shape		
-		(X) طول فریم

